

PIN-PROGRAMMABLE PRECISION CLOCK MULTIPLIER

Features

- Not recommended for new designs. For alternatives, see the Si533x family of products.
- Selectable output frequencies ranging from 19.44 to 1050 MHz
- Low jitter clock outputs with jitter
 LOS alarm output generation as low as 0.6 ps_{RMS} ■ Pin-programmable settings (50 kHz-80 MHz)
- Integrated loop filter with selectable loop bandwidth (150 kHz to 1.3 MHz)
- Dual clock inputs with manual or automatically controlled switching

- Dual clock outputs with selectable signal format: LVPECL, LVDS, CML, CMOS
- Support for ITU G.709 FEC ratios (255/238, 255/237, 255/236)

- On-chip voltage regulator for 1.8 V ±5%, 2.5 or 3.3 V ±10% operation
- Small size: 6 x 6 mm 36-lead QFN
- Pb-free, RoHS compliant



Applications

- SONET/SDH OC-48/STM-16 and OC-192/STM-64 line cards
 Optical modules
- ITU G.709 line cards

 - GbE/10GbE, 1/2/4/8/10GFC line Test and measurement cards

Description

The Si5322 is a low jitter, precision clock multiplier for high-speed communication systems, including SONET OC-48/OC-192, Ethernet, and Fibre Channel. The Si5322 accepts dual clock inputs ranging from 19.44 to 707 MHz and generates two equal frequency-multiplied clock outputs ranging from 19.44 to 1050 MHz. The input clock frequency and clock multiplication ratio are selectable from a table of popular SONET, Ethernet, and Fibre Channel rates.

The Si5322 is based on Skyworks Solutions' 3rd-generation DSPLL® technology, which provides any-frequency synthesis in a highly-integrated PLL solution that eliminates the need for external VCXO and loop filter components. The DSPLL loop bandwidth is digitally programmable, providing jitter performance optimization at the application level.

Operating from a single 1.8, 2.5, or 3.3 V supply, the Si5322 is ideal for providing clock multiplication in high performance timing applications.



Functional Block Diagram



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1. Electrical Specifications

Table 1. Recommended Operating Conditions

(V_{DD} = 1.8 ±5%, 2.5 ±10%, or 3.3 V ±10%, T_A = -40 to 85 °C)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Temperature Range	T _A		-40	25	85	°C
Supply Voltage	V _{DD}	3.3 V nominal	2.97	3.3	3.63	V
		2.5 V nominal	2.25	2.5	2.75	V
		1.8 V nominal	1.71	1.8	1.89	V
	•	ons are guaranteed and appl voltages and an operating to	•		•	

Table 2. DC Characteristics

 $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V} \pm 10\%, \text{ T}_{A} = -40 \text{ to } 85 \text{ °C})$

Symbol	Test Condition	Min	Тур	Max	Unit
I _{DD}	LVPECL Format	—	251	279	mA
	622.08 MHz Out				
	All CKOUTs Enabled ¹				
	LVPECL Format	—	217	243	mA
	622.08 MHz Out				
	Only 1 CKOUT Enabled ¹				
	CMOS Format	—	204	234	mA
	19.44 MHz Out				
	All CKOUTs Enabled				
	CMOS Format	—	194	220	mA
	19.44 MHz Out				
	Only CKOUT1 Enabled				
V _{ICM}	1.8 V ±5%	0.9	—	1.4	V
	2.5 V ±10%	1.0	_	1.7	V
	3.3 V ±10%	1.1	—	1.95	V
CKN _{RIN}	Single-ended	20	40	60	kΩ
CKN _{VIN}	See Note ²	0	—	V _{DD}	V
V _{ISE}	f _{CKIN} ≤ 212.5 MHz See Figure 2.	0.2	—	—	V _{PP}
	f _{CKIN} > 212.5 MHz See Figure 2.	0.25	—	—	V _{PP}
	V _{ICM} CKN _{RIN} CKN _{VIN}	$\begin{tabular}{ c c c c c } \hline I_{DD} & LVPECL Format \\ \hline 622.08 MHz Out \\ All CKOUTs Enabled^1 \\ LVPECL Format \\ \hline 622.08 MHz Out \\ \hline 0nly 1 CKOUT Enabled^1 \\ \hline CMOS Format \\ \hline 19.44 MHz Out \\ \hline All CKOUTs Enabled \\ \hline CMOS Format \\ \hline 19.44 MHz Out \\ \hline 0nly CKOUT1 Enabled \\ \hline \hline V_{ICM} & 1.8 V \pm 5\% \\ \hline 2.5 V \pm 10\% \\ \hline 3.3 V \pm 10\% \\ \hline \hline CKN_{RIN} & Single-ended \\ \hline CKN_{VIN} & See Note 2 \\ \hline V_{ISE} & f_{CKIN} \le 212.5 \text{ MHz} \\ \hline See Figure 2. \\ \hline f_{CKIN} > 212.5 \text{ MHz} \\ \hline \end{tabular}$	$\begin{tabular}{ c c c c c } \hline I_{DD} & LVPECL Format & & & & & & & & & & & & & & & & & &$	$\begin{tabular}{ c c c c c } \hline I_{DD} & $LVPECL Format & & 251 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $622.08 \ MHz \ Out & $$ & 217 \\ \hline $CMOS \ Format & $$ & 217 \\ \hline $CMOS \ Format & $$ & 214 \\ \hline $CMOS \ Format & $$ & 204 \\ \hline $CMOS \ Format & $$ & 204 \\ \hline $CMOS \ Format & $$ & 204 \\ \hline $CMOS \ Format & $$ & 204 \\ \hline $CMOS \ Format & $$ & 204 \\ \hline $CMOS \ Format & $$ & 194 \\ \hline $CMOS \ Format & $$ & $$	$\begin{tabular}{ c c c c c c } \hline V_{\text{IDD}} & LVPECL Format & -& 251 & 279 \\ \hline & 622.08 \mbox{ MHz Out} & -& 217 & 243 \\ \hline & LVPECL Format & -& 217 & 243 \\ \hline & 622.08 \mbox{ MHz Out} & -& 204 & 234 \\ \hline & 0nly 1 \mbox{ CKOUT Enabled}^1 & -& 204 & 234 \\ \hline & 0nly 1 \mbox{ CKOUT Enabled} & -& 204 & 234 \\ \hline & 0nly 4 \mbox{ MHz Out} & -& 194 & 220 \\ \hline & 0nly \mbox{ CKOUTS Enabled} & -& 194 & 220 \\ \hline & 0nly \mbox{ CKOUT Enabled} & -& 194 & 220 \\ \hline & 0nly \mbox{ CKOUT Enabled} & -& 194 & 220 \\ \hline & 0nly \mbox{ CKOUT Enabled} & -& 194 & 220 \\ \hline & 0nly \mbox{ CKOUT Enabled} & -& 194 & 220 \\ \hline & V_{\text{ICM}} & 1.8 \mbox{ V } \pm 5\% & 0.9 & -& 1.4 \\ \hline & 2.5 \mbox{ V } \pm 10\% & 1.0 & -& 1.7 \\ \hline & 3.3 \mbox{ V } \pm 10\% & 1.1 & -& 1.95 \\ \hline & \mbox{ CKN}_{\text{RIN}} & \mbox{ Single-ended} & 20 & 40 & 60 \\ \hline & \mbox{ CKN}_{\text{VIN}} & \mbox{ See Note}^2 & 0 & -& V_{\text{DD}} \\ \hline & V_{\text{ISE}} & \end{tabular} & \begin{tabular}{c c c c c c } f_{\text{CKIN} \end{tabular} & 212.5 \mbox{ MHz} & 0.25 \end{tabular} & -& -& -& -& \\ \hline & f_{\text{CKIN} \end{tabular} & 212.5 \mbox{ MHz} & 0.25 \end{tabular} & -& -& -& -& -& \\ \hline \hline \end{array}$

Notes:

1. LVPECL outputs require nominal $V_{DD} \ge 2.5$ V.

2. No overshoot or undershoot.

3. This is the amount of leakage that the 3L inputs can tolerate from an external driver. See Figure 3 on page 9. In most designs, an external resistor voltage divider is recommended.

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Table 2. DC Characteristics (Continued)

 $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V} \pm 10\%, \text{ T}_{A} = -40 \text{ to } 85 \text{ °C})$

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Differential Input Voltage Swing	V _{ID}	f _{CKIN} ≤ 212.5 MHz See Figure 2.	0.2		_	V _{PP}
		f _{CKIN} > 212.5 MHz See Figure 2.	0.25	—	_	V _{PP}
Output Clocks (CKOUTn) ¹						
Common Mode	CKO _{VCM}	LVPECL 100 Ω load line-to-line	V _{DD} – 1.42	—	V _{DD} – 1.25	V
Differential Output Swing	CKO _{VD}	LVPECL 100 Ω load line-to-line	1.1	—	1.9	V _{PP}
Single-ended Output Swing	CKO _{VSE}	LVPECL 100 Ω load line-to-line	0.5	—	0.93	V _{PP}
Differential Output Voltage	CKO _{VD}	CML 100 Ω load line-to-line	350	425	500	mV _{PP}
Common Mode Output Voltage	CKO _{VCM}	CML 100 Ω load line-to-line	_	V _{DD} – 0.36	—	V
Differential Output Voltage	CKO _{VD}	LVDS 100 Ω load line-to-line	500	700	900	mV _{PP}
		Low swing LVDS 100 Ω load line-to-line	350	425	500	mV _{PP}
Common Mode Output Voltage	CKO _{VCM}	LVDS 100 Ω load line-to-line	1.125	1.2	1.275	V
Differential Output Resistance	CKO _{RD}	CML, LVDS, LVPECL	_	200		Ω
Output Voltage Low	CKO _{VOLLH}	CMOS	—	—	0.4	V
Output Voltage High	CKO _{VOHLH}	V _{DD} = 1.71 V CMOS	0.8 x V _{DD}	—	_	V
Output Drive Current	СКО _Ю	CMOS Driving into CKO _{VOL} for out- put low or CKO _{VOH} for output high. CKOUT+ and CKOUT– shorted externally.				
		V _{DD} = 1.8 V	_	7.5	_	mA
		V _{DD} = 3.3 V	—	32	—	mA

Notes:

1. LVPECL outputs require nominal V_{DD} \geq 2.5 V.

2. No overshoot or undershoot.

3. This is the amount of leakage that the 3L inputs can tolerate from an external driver. See Figure 3 on page 9. In most designs, an external resistor voltage divider is recommended.

Table 2. DC Characteristics (Continued)

(V_{DD} = 1.8 ±5%, 2.5 ±10%, or 3.3 V ±10%, T_A = -40 to 85 °C)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
2-Level LVCMOS Input Pins								
Input Voltage Low	V _{IL}	V _{DD} = 1.71 V	—		0.5	V		
		V _{DD} = 2.25 V	—		0.7	V		
		V _{DD} = 2.97 V	—		0.8	V		
Input Voltage High	V _{IH}	V _{DD} = 1.89 V	1.4		—	V		
		V _{DD} = 2.25 V	1.8		—	V		
	-	V _{DD} = 3.63 V	2.5	—	—	V		
Input Low Current	۱ _{IL}		—		50	μA		
Input High Current	I _{IH}		—		50	μA		
Weak Internal Input Pull-up Resistor	R _{PUP}		—	75	—	kΩ		
Weak Internal Input Pull-down Resistor	R _{PDN}		—	75	—	kΩ		
3-Level Input Pins			<u>.</u>					
Input Voltage Low	V _{ILL}		—		0.15 x V _{DD}	V		
Input Voltage Mid	V _{IMM}		0.45 x V _{DD}	_	$0.55 \times V_{DD}$	V		
Input Voltage High	V _{IHH}		0.85 x V _{DD}		—	V		
Input Low Current	I _{ILL} ³		-20	—	—	μA		
Input Mid Current	۱ _{IMM} ³		-2	—	2	μA		
Input High Current	I _{IHH} 3		—	—	20	μA		
Notes:			- I					

Notes:

1. LVPECL outputs require nominal $V_{DD} \ge 2.5$ V.

2. No overshoot or undershoot.

3. This is the amount of leakage that the 3L inputs can tolerate from an external driver. See Figure 3 on page 9. In most designs, an external resistor voltage divider is recommended.

Table 2. DC Characteristics (Continued)

 $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V} \pm 10\%, \text{ T}_{A} = -40 \text{ to } 85 \text{ °C})$

Symbol	Test Condition	Min	Тур	Мах	Unit
V _{OL}	I _O = 2 mA V _{DD} = 1.71 V	—	—	0.4	V
	I _O = 2 mA V _{DD} = 2.97 V	_	—	0.4	V
V _{OH}	I _O = -2 mA V _{DD} = 1.71 V	V _{DD} – 0.4	—	—	V
	I _O = -2 mA V _{DD} = 2.97 V	V _{DD} – 0.4	—	—	V
I _{OZ}	$\overline{RST} = 0$	-100	—	100	μA
	V _{OL}	$V_{OL} \qquad I_{O} = 2 \text{ mA}$ $V_{DD} = 1.71 \text{ V}$ $I_{O} = 2 \text{ mA}$ $V_{DD} = 2.97 \text{ V}$ $V_{OH} \qquad I_{O} = -2 \text{ mA}$ $V_{DD} = 1.71 \text{ V}$ $I_{O} = -2 \text{ mA}$ $V_{DD} = 2.97 \text{ V}$	$\frac{V_{OL}}{V_{OL}} \frac{I_{O} = 2 \text{ mA}}{V_{DD} = 1.71 \text{ V}} - \frac{V_{OD} = 2.97 \text{ V}}{V_{DD} = 2.97 \text{ V}} - \frac{V_{OD} = -2 \text{ mA}}{V_{DD} = 1.71 \text{ V}} \frac{V_{DD} - 0.4}{V_{DD} = 1.71 \text{ V}} - \frac{V_{DD} - 0.4}{V_{DD} = 2.97 \text{ V}} - \frac{V_{DD} - 0.4}{V_{DD} = 0.4 \text{ V}} - \frac{V_{DD} - 0.4}{V_{DD} = 2.97 \text{ V}} - \frac{V_{DD} - 0.4}{V_{DD} = 0.4 \text{ V}} - \frac{V_{DD} - 0.4 $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\frac{V_{OL}}{V_{OL}} \begin{array}{c c} I_{O} = 2 \text{ mA} & - & - & 0.4 \\ \hline V_{DD} = 1.71 \text{ V} & - & - & 0.4 \\ \hline I_{O} = 2 \text{ mA} & - & - & 0.4 \\ \hline V_{DD} = 2.97 \text{ V} & - & - & 0.4 \\ \hline V_{DD} = 2.97 \text{ V} & - & - & 0.4 \\ \hline V_{DD} = 1.71 \text{ V} & V_{DD} - 0.4 & - & - \\ \hline I_{O} = -2 \text{ mA} & V_{DD} - 0.4 & - & - \\ \hline V_{DD} = 2.97 \text{ V} & V_{DD} - 0.4 & - & - \\ \hline \end{array}$

1. LVPECL outputs require nominal $V_{DD} \ge 2.5$ V.

2. No overshoot or undershoot.

3. This is the amount of leakage that the 3L inputs can tolerate from an external driver. See Figure 3 on page 9. In most designs, an external resistor voltage divider is recommended.



Figure 2. Rise/Fall Time Characteristics

Table 3. AC Characteristics

(V_{DD} = 1.8 ±5%, 2.5 ±10%, or 3.3 V ±10%, T_A = -40 to 85 °C)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
CKIN Input Pins					1	
Input Frequency	CKN _F		19.44	_	707.35	MHz
Input Duty Cycle		Whichever is smaller	40	_	60	%
(Minimum Pulse Width)	CKN _{DC}	(i.e., the 40%/60% limitation applies only to high clock frequencies)	2	_		ns
Input Capacitance	CKN _{CIN}				3	pF
Input Rise/Fall Time	CKN _{TRF}	20–80% See Figure 2	_	_	11	ns
CKOUTn Output Pins						
Output Frequency (Output not configured for CMOS or disable)	CK _{OF}		19.44	_	1050	MHz
Maximum Output Frequency in CMOS Format	CKO _{FMC}			_	212.5	MHz
Single-ended Output Rise/Fall (20–80%)	CKO _{TRF}	CMOS Output V _{DD} = 1.71 Cload = 5 pF	_	_	8	ns
		CMOS Output V _{DD} = 2.97 Cload = 5 pF		_	2	ns
Differential Output Rise/Fall Time	CKO _{TRF}	20 to 80 %, f _{OUT} = 622.08	_	230	350	ps
Output Duty Cycle Differential Uncertainty	CKO _{DC}	100 Ω Load Line to Line Measured at 50% Point (not for CMOS)		_	±40	ps
LVCMOS Input Pins	•					•
Minimum Reset Pulse Width	t _{RSTMIN}		1		—	μs
Input Capacitance	C _{IN}		_		3	pF
LVCMOS Output Pins						
Rise/Fall Times	t _{RF}	C _{LOAD} = 20 pf See Figure 2	_	25	—	ns
LOSn Trigger Window	LOS _{TRIG}	From last CKIN↑ to LOS↑			750	μs
PLL Performance						
Output Clock Phase Change	t _{P_STEP}	After clock switch f3 ≥ 128 kHz		200	—	ps
Closed Loop Jitter Peaking	J _{PK}			0.05	0.1	dB
Jitter Tolerance	J _{TOL}	BW determined by BWSEL[1:0]	5000/ BW		—	ns pk- pk
Spurious Noise	SP _{SPUR}	Max spur @ n x f3 (n ≥ 1, n x f3 < 100 MHz)	_	-93	-70	dBc
Phase Change due to Temperature Variation	t _{TEMP}	Max phase changes from – 40 to +85 °C		300	500	ps

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1.1. Three-Level (3L) Input Pins (No External Resistors)



Figure 3. Three-Level Input Pins

1.2. Three-Level Input Pins (Example with External Resistors)



One of eight resistors from a Panasonic EXB-D10C183J (or similar) resistor pack

Figure 4. Three-Level Input Pins

Table 4. Three-Level Input Pins^{1,2,3,4}

Parameter	Min	Max
Input Low Current	–30 μA	—
Input Mid Current	–11 μA	–11 μA
Input High Current	_	–30 μA

Notes:

1. The current parameters are the amount of leakage that the 3L inputs can tolerate from an external driver using the external resistor values indicated in this example. In most designs, an external resistor voltage divider is recommended.

2. Resistor packs are only needed if the leakage current of the external driver exceeds the current specified in Table 2, limm. Any resistor pack may be used (e.g., Panasonic EXB-D10C183J). PCB layout is not critical.

- 3. If a pin is tied to ground or V_{DD} , no resistors are needed.
- 4. If a pin is left open (no connect), no resistors are needed.

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Table 5. Performance Specifications^{1, 2, 3, 4}

 $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V} \pm 10\%, \text{ T}_{A} = -40 \text{ to } 85 \text{ }^{\circ}\text{C})$

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Jitter Generation	J _{GEN}	50 kHz–80 MHz	—	.47	—	ps rms
$f_{IN} = f_{OUT} = 622.08 \text{ MHz},$		12 kHz–20 MHz	—	.48	—	ps rms
LVPECL Output Format BW = 877 Hz		4 MHz–80 MHz		.23	—	ps rms
Phase Noise	CKO _{PN}	1 kHz offset	—	-90	—	dBc/Hz
f _{IN} = f _{OUT} = 622.08 MHz LVPECL Output Format		10 kHz offset		-113		dBc/Hz
	onnat	100 kHz offset		-118		dBc/Hz
		1 MHz offset	—	-132	—	dBc/Hz

Notes:

1. BWSEL [1:0] loop bandwidth settings provided in by DSPLLsim.

2. $V_{DD} = 3.3 V$

3. $T_A = 85 \ ^{\circ}C$

 Test condition: f_{IN} = 622.08 MHz, f_{OUT} = 622.08 MHz, LVPECL clock input: 1.19 Vppd with 0.5 ns rise/fall time (20-80%), LVPECL clock output.

Table 6. Thermal Characteristics

 $(V_{DD} = 1.8 \pm 5\%, 2.5 \pm 10\%, \text{ or } 3.3 \text{ V} \pm 10\%, \text{ T}_{A} = -40 \text{ to } 85 \text{ }^{\circ}\text{C})$

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Thermal Resistance Junction to Ambient	θ_{JA}	Still Air	_	32	_	°C/W
Thermal Resistance Junction to Case	θJC	Still Air	_	14	_	°C/W

Table 7. Absolute Maximum Ratings

Parameter	Symbol	Value	Unit			
DC Supply Voltage	V _{DD}	-0.5 to 3.8	V			
LVCMOS Input Voltage	V _{DIG}	–0.3 to (V _{DD} + 0.3)	V			
CKINn Voltage Level Limits	CKN _{VIN}	0 to V _{DD}	V			
Operating Junction Temperature	T _{JCT}	-55 to 150	С			
Storage Temperature Range	T _{STG}	-55 to 150	С			
ESD HBM Tolerance (100 pF, 1.5 k Ω); All pins except CKIN+/CKIN–		2	kV			
ESD MM Tolerance; All pins except CKIN+/CKIN-		150	V			
ESD HBM Tolerance (100 pF, 1.5 kΩ); CKIN+/CKIN–		750	V			
ESD MM Tolerance; CKIN+/CKIN–		100	V			
Latch-Up Tolerance		JESD78 Compli	ant			
Note: Permanent device damage may occur if the Absolute Maximum Ratings are exceeded. Functional operation should be restricted to the conditions as specified in the operation sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods of time may affect device reliability.						

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Figure 5. Typical Phase Noise Plot

Jitter Bandwidth	RMS Jitter (fs)
OC-48, 12 kHz to 20 MHz	374
OC-192, 20 kHz to 80 MHz	388
OC-192, 4 MHz to 80 MHz	181
OC-192, 50 kHz to 80 MHz	377
Broadband, 800 Hz to 80 MHz	420

Table 8. Typical Jitter Data



3. Assumes manual input clock selection.

Figure 6. Si5322 Typical Application Circuit

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2. Functional Description

The Si5322 is a low jitter, precision clock multiplier for high-speed communication systems, including SONET OC-48/OC-192, SDH STM-16/64 Ethernet, and Fibre Channel. The Si5322 accepts dual clock inputs ranging from 19.44 to 707 MHz and generates two frequencymultiplied clock outputs ranging from 19.44 to 1050 MHz. The two input clocks are at the same frequency and the two output clocks are at the same frequency.

The input clock frequency and clock multiplication ratio are selectable from a table of popular SONET, Ethernet, and Fibre Channel rates. In addition to providing clock multiplication in SONET and datacom applications, the Si5322 supports SONET-to-datacom frequency translations.

Skyworks Solutions offers a PC-based software utility, DSPLL*sim*, that can be used to look up valid Si5322 frequency translations. This utility can be downloaded from https://www.skyworksinc.com/en/Products/Timing.

The Si5322 is recommended for applications in which the input clock is relatively low jitter and only clock multiplication is required. The Si5322 is based on Skyworks Solutions' 3rd-generation DSPLL[®] technology, which provides any-frequency synthesis in a highly integrated PLL solution that eliminates the need for external VCXO and loop filter components. The Si5322 PLL loop bandwidth is selectable via the BWSEL[1:0] pins and supports a range from 150 kHz to 1.5 MHz. The DSPLLsim software utility can be used to calculate valid loop bandwidth settings for a given input clock frequency/clock multiplication ratio. The Si5322 monitors all input clocks for loss of signal and provides a LOS alarm when it detects a missing clock.

In the case when the input clocks enter alarm conditions, the PLL will freeze the DCO output frequency near its last value to maintain operation with an internal state close to the last valid operating state.

The Si5322 has two differential clock outputs. The electrical format of the clock outputs is programmable to support LVPECL, LVDS, CML, or CMOS loads. If not required, the second clock output can be powered down to minimize power consumption. For system-level debugging, a bypass mode is available which drives the output clock directly from the input clock, bypassing the internal DSPLL. The device is powered by a single 1.8, 2.5, or 3.3 V supply.

2.1. Further Documentation

Consult the Skyworks Solutions Any-Frequency Precision Clock Family Reference Manual (FRM) for detailed information about the Si5322. Additional design support is available from Skyworks Solutions through your distributor.

Skyworks Solutions has developed a PC-based software utility called DSPLL*sim* to simplify device configuration, including frequency planning and loop bandwidth selection.

The FRM and this utility can be downloaded from https://www.skyworksinc.com/en/Products/Timing.

3. Pin Descriptions: Si5322



Table 9. Si5322 Pin Descriptions

Pin #	Pin Name	I/O	Signal Level	Description
1	RST	I	LVCMOS	External Reset. Active low input that performs external hardware reset of device. Resets all internal logic to a known state. <u>Clock</u> outputs are tristated during reset. After rising edge of RST signal, the Si5322 will perform an internal self-calibration. This pin has a weak pull-up.
2	FRQTBL	I	3-Level	Frequency Table Select. Selects SONET/SDH, datacom, or SONET/SDH to datacom frequency table. L = SONET/SDH. M = Datacom. H = SONET/SDH to Datacom. The pin has a weak pull-up and weak pull-down and defaults to M. Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
3	C1B	0	LVCMOS	 CKIN1 Loss of Signal. Active high loss-of-signal indicator for CKIN1. Once triggered, the alarm will remain active until CKIN1 is validated. 0 = CKIN1 present. 1 = LOS on CKIN1.
4	C2B	0	LVCMOS	 CKIN2 Loss of Signal. Active high loss-of-signal indicator for CKIN2. Once triggered, the alarm will remain active until CKIN2 is validated. 0 = CKIN2 present. 1 = LOS on CKIN2.

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Pin #	Pin Name	I/O	Signal Level	Description
5, 10, 11, 15, 32	V _{DD}	V _{DD}	Supply	$\label{eq:supply} \begin{array}{l} \textbf{Supply.} \\ The device operates from a 1.8, 2.5, or 3.3 V supply. Bypass capacitors should be associated with the following V_{DD} pins: \\ 5 & 0.1 \ \mu F \\ 10 & 0.1 \ \mu F \\ 32 & 0.1 \ \mu F \\ A 1.0 \ \mu F \ should be placed as close to device as is practical. \end{array}$
6, 8,19, 20, 31	GND	GND	Supply	Ground. Must be connected to system ground. Minimize the ground path impedance for optimal performance of this device.
9	AUTOSEL	1	3-Level	 Manual/Automatic Clock Selection. Three level input that selects the method of input clock selection to be used. L = Manual. M = Automatic non-revertive. H = Automatic revertive. The pin has a weak pull-up and weak pull-down and defaults to M. Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
12 13	CKIN2+ CKIN2–	I	Multi	Clock Input 2. Differential input clock. This input can also be driven with a single-ended signal. Input frequency selected from a table of values. The same frequency must be applied to CKIN1 and CKIN2.
14	DBL2_BY	I	3-Level	Output 2 Disable/Bypass Mode Control. Controls enable of CKOUT2 divider/output buffer path and PLL bypass mode. L = CKOUT2 enabled. M = CKOUT2 disabled. H = Bypass mode with CKOUT2 enabled. CMOS outputs do not support Bypass Mode. The pin has a weak pull-up and weak pull-down and defaults to M. Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.
16 17	CKIN1+ CKIN1–	I	Multi	Clock Input 1. Differential input clock. This input can also be driven with a single-ended signal. Input frequency selected from a table of values. The same frequency must be applied to CKIN1 and CKIN2.

Table 9. Si5322 Pin Descriptions (Continued)

Pin #	Pin Name	I/O	Signal Level	Description
21	CS_CA	I/O	LVCMOS	 Input Clock Select/Active Clock Indicator. Input: If manual clock selection mode is chosen (AUTOSEL = L), this pin functions as the manual input clock selector. This input is internally deglitched to prevent inadvertent clock switching during changes in the CS input state. 0 = Select CKIN1. 1 = Select CKIN2. If configured as input, must be set high or low. Output: If automatic clock selection mode is chosen (AUTOSEL = M or H), this pin indicates which of the two input clocks is currently the active clock. If alarms exist on both CKIN1 and CKIN2, indicating that the digital hold state has been entered, CA will indicate the last active clock that was used before entering the hold state. 0 = CKIN1 active input clock. 1 = CKIN2 active input clock.
23 22	BWSEL1 BWSEL0	I	Bandwidth Select.Three level inputs that select the DSPLL closed lood width. Detailed operations and timing characteristic these pins may be found in the Any-Frequency Pre- Clock Family Reference Manual.3-LevelClock Family Reference Manual. These pins have both weak pull-ups and weak pull and default to M. Some designs may require an external resistor vol divider when driven by an active device that will tri	
27 26 25 24	FRQSEL3 FRQSEL2 FRQSEL1 FRQSEL0	I	3-Level	Multiplier Select. Three level inputs that select the input clock and clock multi- plication ratio, depending on the FRQTBL setting. Consult the Any-Frequency Precision Clock Family Refer- ence Manual or DSPLL <i>sim</i> configuration software for set- tings, both available for download at https://www.skyworksinc.com/en/Products/Timing These pins have both weak pull-ups and weak pull-downs and default to M. Some designs may require an external resistor voltage divider when driven by an active device that will tri-state.

Table 9. Si5322 Pin Descriptions (Continued)

Pin #	Pin Name	I/O	Signal Level		Des	scription	
				Three level mon mode and CKOU CML. Also	voltage and diffe T2. Valid settings	ct the output signal forma erential swing) for both Cl s include LVPECL, LVDS ins for CMOS mode, trist ode.	KOUT1 , and
					SFOUT[1:0]	Signal Format	
					HH	Reserved	
					HM	LVDS	
					HL	CML	
33 30	SFOUT0 SFOUT1	Ι	3-Level		MH	LVPECL	
30	5F0011				MM	Reserved	
					ML	LVDS—Low Swing	
					LH	CMOS	
					LM	Disabled	
					LL	Reserved	
				These pins and default Some desig	have both weak to M. gns may require	ort Bypass Mode. pull-ups and weak pull-o an external resistor volta ctive device that will tri-s	ge
34 35	CKOUT2– CKOUT2+	0	Multi	Clock Output 2. Differential output clock with a frequency selected from a table of values. Output signal format is selected by SFOUT pins. Output is differential for LVPECL, LVDS, and CML compatible modes. For CMOS format, both output pins drive identical single-ended clock outputs.		SFOUT ML	
29 28	CKOUT1– CKOUT1+	ο	Multi	Clock Output 1. Differential output clock with a frequency selected from a table of values. Output signal format is selected by SFOUT pins. Output is differential for LVPECL, LVDS, and CML compatible modes. For CMOS format, both output pins drive identical single-ended clock outputs.			
7, 18, 36	NC		_	No Connect. These pins must be left unconnected for normal operation.			
GND PAD	GND	GND	Supply	Ground Pad. The ground pad must provide a low thermal and electrical impedance to a ground plane.			

Table 9. Si5322	Pin Descriptions	(Continued)
	= • • • •	(•••••)

4. Ordering Guide

Ordering Part Number	Package	ROHS6, Pb-Free	Temperature Range		
Si5322-C-GM*	36-Lead 6 x 6 mm QFN	Yes	–40 to 85 °C		
*Note: Not recommended for new designs. For alternatives, see the Si533x family.					

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5. Package Outline: 36-Pin QFN

Figure 7 illustrates the package details for the Si5322. Table 10 lists the values for the dimensions shown in the illustration.



Figure 7. 36-Pin Quad Flat No-lead (QFN)

Table 10. F	Package D	imens	sions	5

Symbol	Millimeters		
	Min	Nom	Max
А	0.80	0.85	0.90
A1	0.00	0.02	0.05
b	0.18	0.25	0.30
D	6.00 BSC		
D2	3.95	4.10	4.25
е	0.50 BSC		
Е	6.00 BSC		
E2	3.95	4.10	4.25

Symbol	Millimeters				
	Min	Nom	Мах		
L	0.50	0.60	0.70		
θ	—	_	12º		
aaa	_		0.10		
bbb	_		0.10		
CCC	_		0.08		
ddd —			0.10		
eee		_	0.05		

Notes:

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
- 3. This drawing conforms to JEDEC outline MO-220, variation VJJD.
- 4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

6. Land Pattern: 36-Pin QFN



Figure 8. 36-Pin QFN Land Pattern

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Table 11. PCB Land Pattern Dimensions

Dimension	MIN	MAX
e	0.50	BSC.
E	5.42	REF.
D	5.42	REF.
E2	4.00	4.20
D2	4.00	4.20
GE	4.53	_
GD	4.53	_
Х	_	0.28
Y	0.89	REF.
ZE	-	6.31
ZD	—	6.31

Notes:

General

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- **2.** Dimensioning and Tolerancing is per the ANSI Y14.5M-1994 specification.
- 3. This Land Pattern Design is based on IPC-SM-782 guidelines.
- **4.** All dimensions shown are at Maximum Material Condition (MMC). Least Material Condition (LMC) is calculated based on a Fabrication Allowance of 0.05 mm.

Solder Mask Design

 All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 µm minimum, all the way around the pad.

Stencil Design

- **6.** A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
- 7. The stencil thickness should be 0.125 mm (5 mils).
- **8.** The ratio of stencil aperture to land pad size should be 1:1 for the perimeter pads.
- **9.** A 4 x 4 array of 0.80 mm square openings on 1.05 mm pitch should be used for the center ground pad.

Card Assembly

- **10.** A No-Clean, Type-3 solder paste is recommended.
- **11.** The recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

7. Top Marking

7.1. Si5322 Top Marking (QFN)



7.2. Top Marking Explanation

Mark Method:	Laser	
Font Size:	0.80 mm Right-Justified	
Line 1 Marking:	Si5322	Customer Part Number See Ordering Guide for options
Line 2 Marking:	C-GM	C = Product Revision G = Temperature Range –40 to 85 °C (RoHS6) M = QFN Package
Line 3 Marking:	YYWWRF	YY = Year WW = Work Week R = Die Revision F = Internal code Assigned by the Assembly House. Corresponds to the year and work week of the mold date.
Line 4 Marking:	Pin 1 Identifier	Circle = 0.75 mm Diameter Lower-Left Justified
	XXXX	Internal Code

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DOCUMENT CHANGE LIST

Revision 0.44 to Revision 0.45

Condensed format.

Revision 0.45 to Revision 0.46

- Removed references to latency control, INC, and DEC in figures and text.
- Changed LVTTL to LVCMOS in Table 2, "Absolute Maximum Ratings," on page 5.
- Added Figure 1, "Typical Phase Noise Plot," on page 4.
- Updated "3. Pin Descriptions: Si5322".
- Added "6. Land Pattern: 36-Pin QFN".

Revision 0.46 to Revision 0.47

- Removed Figure 1. "Typical Phase Noise Plot."
- Changed pins 11 and 15 from NC to VDD in "3. Pin Descriptions: Si5322".

Revision 0.47 to Revision 0.5

- Changed 1.8 V operating range to ±5%.
- Updated Table 1 on page 4.
- Updated Table 2 on page 5.
- Updated Figure 6 on page 12 to add pull-up/pulldown resistors for 3-level inputs.
- Added figure and table on page 11.
- Updated "2. Functional Description" on page 13.
- Clarified "3. Pin Descriptions: Si5322" on page 14.
- Updated SFOUT values.

Revision 0.5 to Revision 0.51

- Changed "any-rate" to "any-frequency" throughout.
- Expanded spec tables 1 through 7.
- Updated Table 5 on page 10.
- Added "7. Top Marking" on page 22.
- Added clarification that CMOS output format is not available in PLL bypass mode.
- Updated "4. Ordering Guide" on page 18.
- Removed note from "3. Pin Descriptions: Si5322" on page 14.

Revision 0.51 to Revision 1.0

- Updated logo.
- Transitioned to full production.

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